



ON Semiconductor®

FDD8453LZ-F085

N-Channel Power Trench® MOSFET

40V, 50A, 6.5mΩ

Features

- Typ $r_{DS(on)} = 5\text{m}\Omega$ at $V_{GS} = 10\text{V}$, $I_D = 15\text{A}$
- Typ $r_{DS(on)} = 6\text{m}\Omega$ at $V_{GS} = 4.5\text{V}$, $I_D = 13\text{A}$
- HBM ESD protection level > 7kv typical
- RoHS Compliant
- Qualified to AEC Q101

General Description

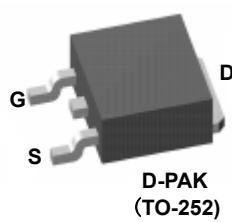
This N-Channel MOSFET is produced using ON Semiconductor's advanced PowerTrench® process that has been especially tailored to minimize the on-state resistance and switching loss. G-S zener has been added to enhance ESD voltage level.

Applications

- Inverter
- Synchronous Rectifier

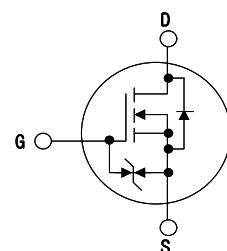


Package



**D-PAK
(TO-252)**

Symbol



MOSFET Maximum Ratings $T_C = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Ratings	Units
V_{DSS}	Drain to Source Voltage	40	V
V_{GS}	Gate to Source Voltage	± 20	V
I_D	Drain Current - Continuous (Package limited) $T_C = 25^\circ\text{C}$	50	A
	-Pulsed	Figure4	
E_{AS}	Single Pulse Avalanche Energy (Note 1)	88	mJ
P_D	Power Dissipation	118	W
	Derate above 25°C	0.79	W/ $^\circ\text{C}$
T_J, T_{STG}	Operating and Storage Temperature	-55 to + 175	$^\circ\text{C}$

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance Junction to Case	1.27	$^\circ\text{C/W}$
$R_{\theta JA}$	Thermal Resistance Junction to Ambient, 1in ² copper pad area	52	$^\circ\text{C/W}$

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD8453LZ	FDD8453LZ-F085	D-PAK(TO-252)	13"	12mm	2500 units

Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
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Off Characteristics

$B_{V_{DSS}}$	Drain to Source Breakdown Voltage	$I_D = 250\mu\text{A}, V_{GS} = 0\text{V}$	40	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 32\text{V},$	-	-	1	μA
		$V_{GS} = 0\text{V}$ $T_C = 150^\circ\text{C}$	-	-	250	
I_{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20\text{V}$	-	-	± 10	μA

On Characteristics

$V_{GS(\text{th})}$	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250\mu\text{A}$	1.0	1.8	3.0	V
$r_{DS(\text{on})}$	Drain to Source On Resistance	$I_D = 15\text{A}, V_{GS} = 10\text{V}$	-	5.0	6.5	$\text{m}\Omega$
		$I_D = 13\text{A}, V_{GS} = 4.5\text{V}$	-	6.0	7.8	$\text{m}\Omega$
		$I_D = 15\text{A}, V_{GS} = 10\text{V}$ $T_J = 175^\circ\text{C}$	-	9.4	12.2	$\text{m}\Omega$
g_{FS}	Forward Transconductance	$V_{DS} = 5\text{V}, I_D = 15\text{A}$	-	91	-	S

Dynamic Characteristics

C_{iss}	Input Capacitance	$V_{DS} = 20\text{V}, V_{GS} = 0\text{V},$ $f = 1\text{MHz}$	-	2935	-	pF
C_{oss}	Output Capacitance		-	340	-	pF
C_{rss}	Reverse Transfer Capacitance		-	260	-	pF
R_g	Gate Resistance		-	1.8	-	Ω
$Q_{g(\text{ToT})}$	Total Gate Charge at 10V	$V_{GS} = 0 \text{ to } 10\text{V}$	-	60	78	nC
$Q_{g(5)}$	Total Gate Charge at 5V		-	32	42	nC
Q_{gs}	Gate to Source Gate Charge		-	7.5	-	nC
Q_{gd}	Gate to Drain "Miller" Charge		-	13	-	nC

Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
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Switching Characteristics

t_{on}	Turn-On Time	$V_{DD} = 20\text{V}$, $I_D = 15\text{A}$, $V_{GS} = 10\text{V}$, $R_{GEN} = 6\Omega$	-	-	34	ns
$t_{d(on)}$	Turn-On Delay Time		-	12	-	ns
t_r	Rise Time		-	10	-	ns
$t_{d(off)}$	Turn-Off Delay Time		-	43	-	ns
t_f	Fall Time		-	7	-	ns
t_{off}	Turn-Off Time		-	-	80	ns

Drain-Source Diode Characteristics

V_{SD}	Source to Drain Diode Voltage	$I_{SD} = 2\text{A}$	-	0.7	1.2	V
		$I_{SD} = 15\text{A}$	-	0.8	1.3	V
t_{rr}	Reverse Recovery Time	$I_F = 15\text{A}$, $dI_{SD}/dt = 100\text{A}/\mu\text{s}$	-	25	33	ns
			-	14	19	nC

Notes:

1: Starting $T_J = 25^\circ\text{C}$, $L = 0.11\text{mH}$, $I_{AS} = 40\text{A}$, $V_{DD} = 36\text{V}$ during inductor charging and $V_{DD} = 0\text{V}$ during the time in Avalanche.

This product has been designed to meet the extreme test conditions and environment demanded by the automotive industry. For a copy of the requirements, see AEC Q101 at: <http://www.aecouncil.com/>
All ON Semiconductor products are manufactured, assembled and tested under ISO9000 and QS9000 quality systems certification.

Typical Characteristics

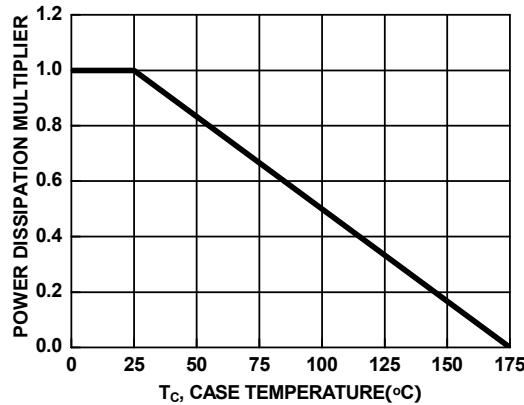


Figure 1. Normalized Power Dissipation vs Case Temperature

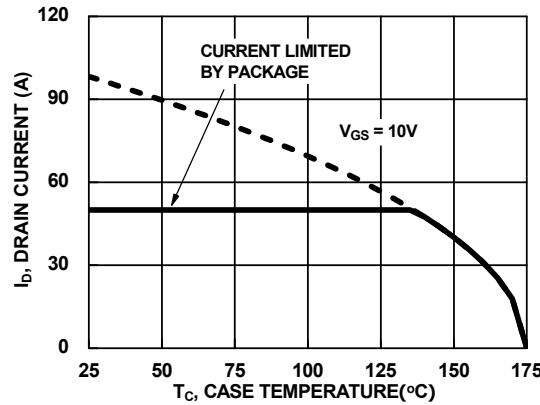


Figure 2. Maximum Continuous Drain Current vs Case Temperature

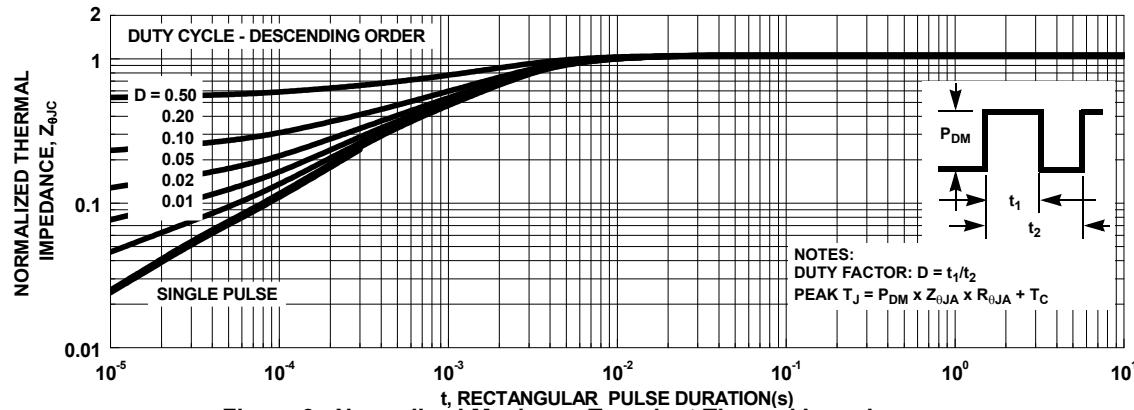


Figure 3. Normalized Maximum Transient Thermal Impedance

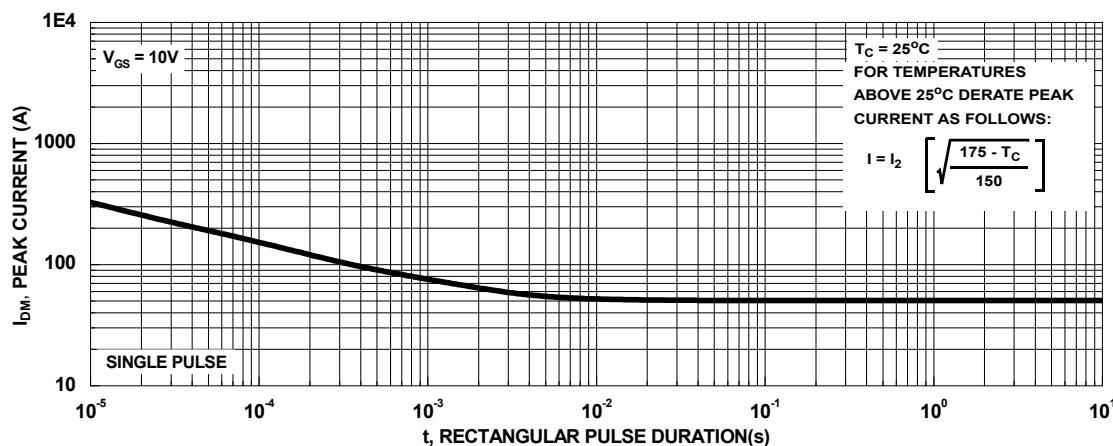


Figure 4. Peak Current Capability

Typical Characteristics

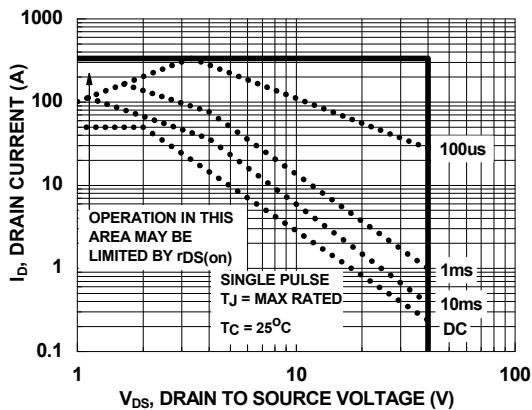
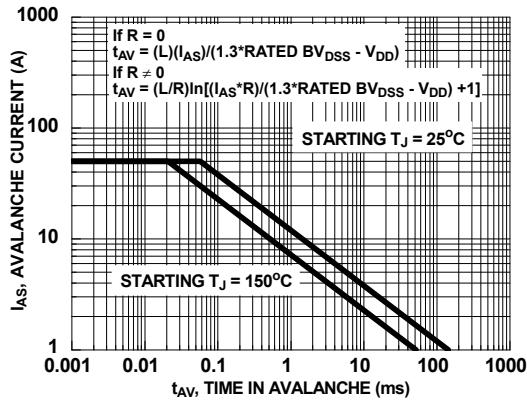


Figure 5. Forward Bias Safe Operating Area



NOTE: Refer to ON Semiconductor Application Notes AN7514 and AN7515

Figure 6. Unclamped Inductive Switching Capability

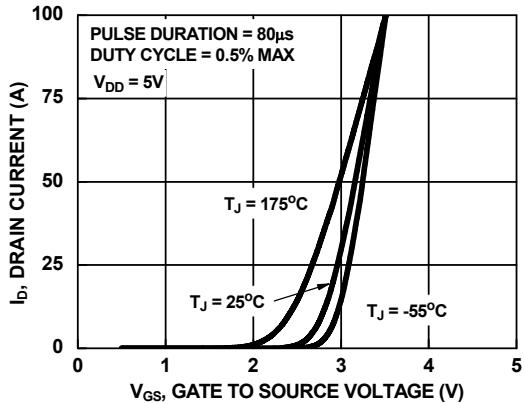


Figure 7. Transfer Characteristics

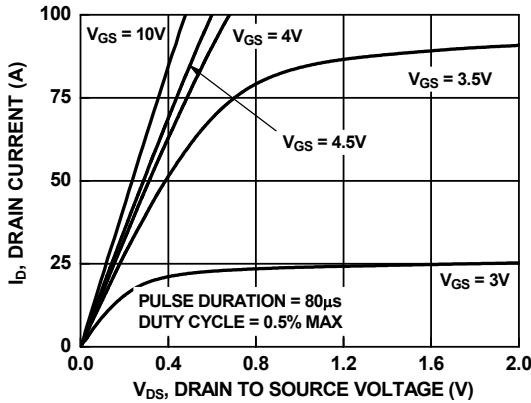


Figure 8. Saturation Characteristics

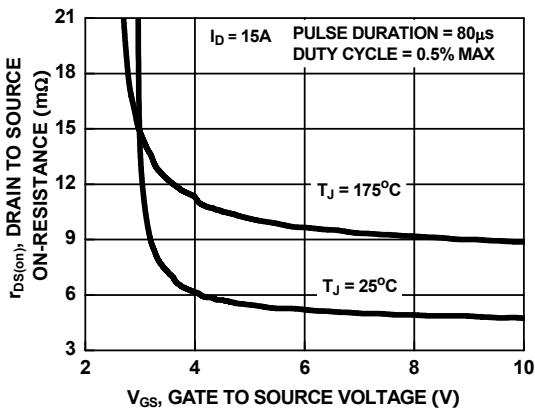


Figure 9. Drain to Source On-Resistance Variation vs Gate to Source Voltage

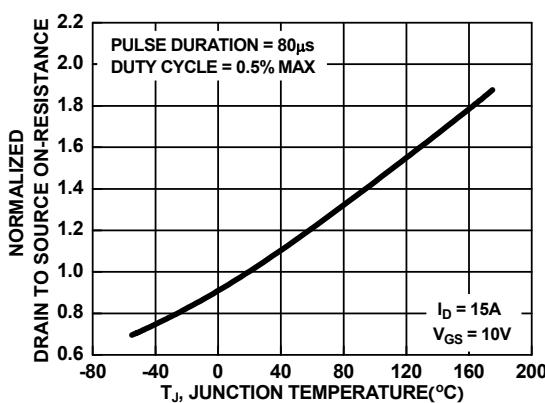


Figure 10. Normalized Drain to Source On Resistance vs Junction Temperature

Typical Characteristics

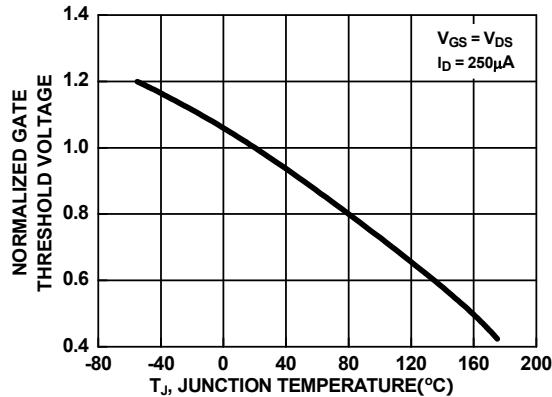


Figure 11. Normalized Gate Threshold Voltage vs Junction Temperature

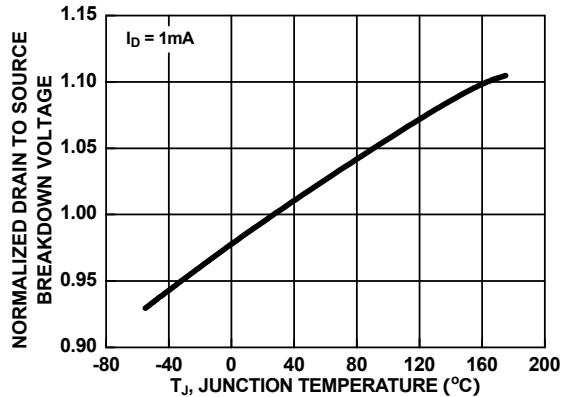


Figure 12. Normalized Drain to Source Breakdown Voltage vs Junction Temperature

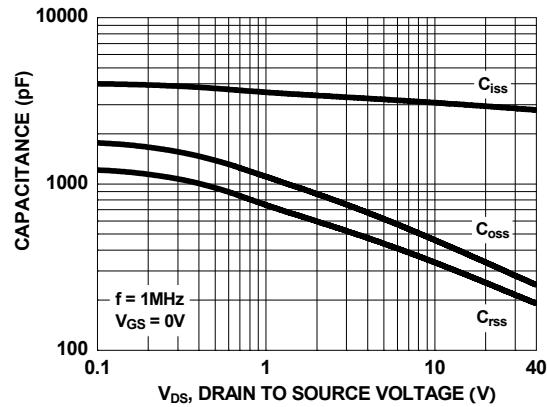


Figure 13. Capacitance vs Drain to Source Voltage

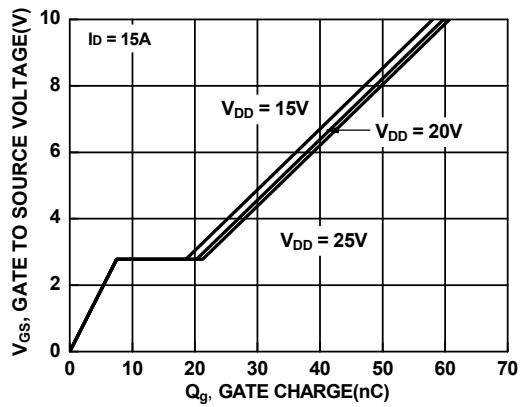


Figure 14. Gate Charge vs Gate to Source Voltage

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